

APBL3025SURKCGK-F01

3.0 x 2.5 mm Surface Mount LED Lamp



DESCRIPTIONS

- The Hyper Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode
- The Green source color devices are made with AIGaInP on GaAs substrate Light Emitting Diode
- · Electrostatic discharge and power surge could damage the LEDs
- · It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- · All devices, equipments and machineries must be electrically grounded

FEATURES

- 3.0 mm x 2.5 mm SMD LED, 1.4 mm thickness
- Low power consumption
- Wide viewing angle
- Ideal for backlight and indicator
- Inner lens type
- Package: 2000 pcs / reel
- Moisture sensitivity level: 3
- Halogen-free
- RoHS compliant

APPLICATIONS

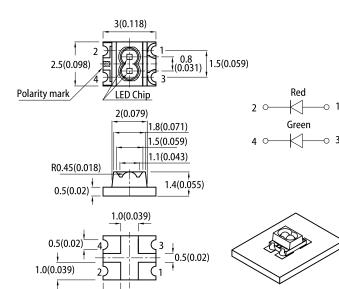
- Backlight
- · Status indicator
- · Home and smart appliances
- · Wearable and portable devices
- · Healthcare applications

ATTENTION

Observe precautions for handling electrostatic discharge sensitive devices

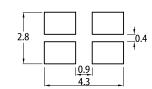


PACKAGE DIMENSIONS



RECOMMENDED SOLDERING PATTERN

(units : mm; tolerance : ± 0.1)



1.0(0.039)



All dimensions are in millimeters (inches).
 Tolerance is ±0.2(0.008") unless otherwise noted.

The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
 The device has a single mounting surface. The device must be mounted according to the specifications.

SELECTION GUIDE

Part Number	Emitting Color (Material)	Lens Type	lv (mcd) @ 20mA ^[2]		Viewing Angle ^[1]	
			Min.	Тур.	201/2	
APBL3025SURKCGK-F01		Water Clear	500	1000		
	Hyper Red (AlGaInP)		*120	*300	50°	
	Green (AlGaInP)		80	150	50	
			*80	*150		

Notes

1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
 2. Luminous intensity / luminous flux: +/-15%.
 * Luminous intensity value is traceable to CIE127-2007 standards.

ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	Symbol	Emitting Color	Value		11:::4
Falameter			Тур.	Max.	Unit
Wavelength at Peak Emission I_F = 20mA	λ_{peak}	Hyper Red Green	645 574	-	nm
Dominant Wavelength I _F = 20mA	λ_{dom} ^[1]	Hyper Red Green	630 570	-	nm
Spectral Bandwidth at 50% Φ REL MAX I _F = 20mA	Δλ	Hyper Red Green	28 20	-	nm
Forward Voltage $I_F = 20 \text{mA}$	V _F ^[2]	Hyper Red Green	1.95 2.1	2.5 2.5	V
Reverse Current ($V_R = 5V$)	I _R	Hyper Red Green	-	10 10	μA
Temperature Coefficient of λ_{peak} I _F = 20mA, -10°C \leq T \leq 85°C	TC_{\lambdapeak}	Hyper Red Green	0.14 0.12	-	nm/°C
Temperature Coefficient of λ_{dom} I_F = 20mA, -10°C \leq T \leq 85°C	TC _{λdom}	Hyper Red Green	0.05 0.08	-	nm/°C
Temperature Coefficient of V_F I_F = 20mA, -10°C \leq T \leq 85°C	TCv	Hyper Red Green	-1.9 -1.9	-	mV/°C

Notes:

1. The dominant wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd : ±1nm.)
 2. Forward voltage: ±0.1V.
 3. Wavelength value is traceable to CIE127-2007 standards.
 4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

Parameter	Symbol	Va	Unit	
Falameter		Hyper Red	Green	Onit
Power Dissipation	P _D	75	75	mW
Reverse Voltage	V _R	5	5	V
Junction Temperature	TJ	115	115	°C
Operating Temperature	T _{op}	-40 To +85		°C
Storage Temperature	T _{stg}	-40 To +85		°C
DC Forward Current	I _F	30	30	mA
Peak Forward Current	I _{FP} ^[1]	185	150	mA
Electrostatic Discharge Threshold (HBM)	-	3000	3000	V
Thermal Resistance (Junction / Ambient)	R _{th JA} ^[2]	580	560	°C/W
Thermal Resistance (Junction / Solder point)	R _{th JS} ^[2]	460	440	°C/W

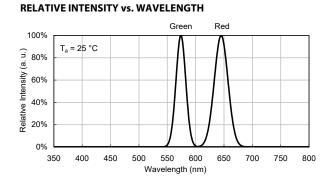
ABSOLUTE MAXIMUM RATINGS at $T_A=25^{\circ}C$

Notes: 1. 1/10 Duty Cycle, 0.1ms Pulse Width. 2. R_{th. us}, R_{m. us} Results from mounting on PC board FR4 (pad size ≥ 16 mm² per pad). 3. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

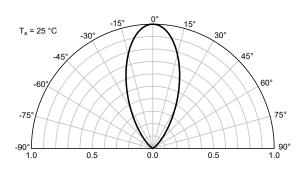
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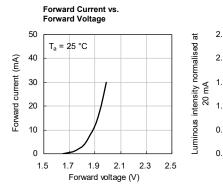
TECHNICAL DATA

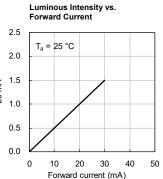


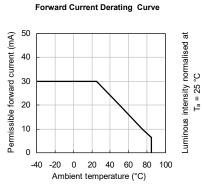
SPATIAL DISTRIBUTION



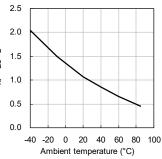
HYPER RED

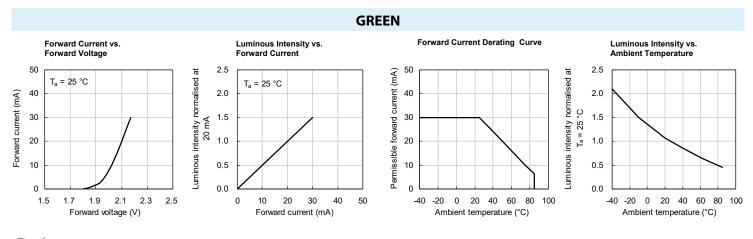








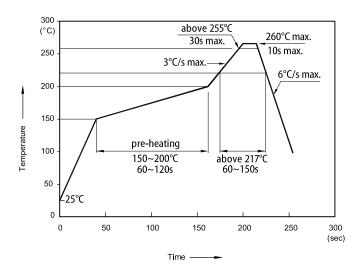




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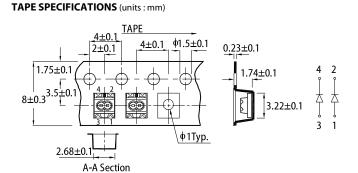
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REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS

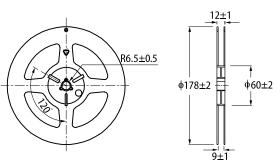


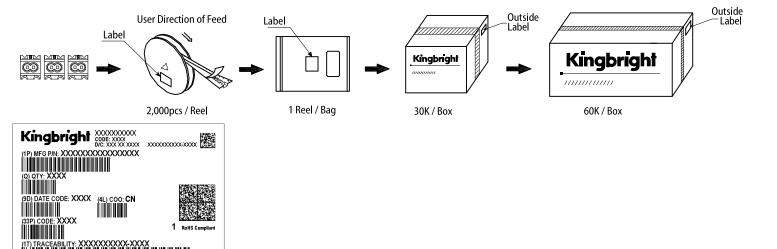
- Cont cause stress to the LEDs while it is exposed to high temperature.
 The maximum number of reflow soldering passes is 2 times.
 Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

PACKING & LABEL SPECIFICATIONS



REEL DIMENSION (units : mm)





PRECAUTIONARY NOTES

(SP) XXXXXXXXXXX

- The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- 2. The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
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